Made in Germany



Product Information

FELDER-ISO-Cream® "EL 42/58", Bi58Sn42

Odourless No-Clean Solder paste for solderings of temperature sensitive components Flux, DIN EN 29454.1, 1.1.3.C, DIN EN 61190-1-3, ROL1, IPC J-STD-004B, ROL1 Metal powder content 80 % - 89 %

Art.-Nr.: 23233242...

All information about our products is the result of our long standing experience which we would like to pass on to our customers as application support. However, as we do not have any influence on the application of the works carried out with our products, please see the warranty claims in our conditions of sale because our liability is limited.

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Description

The solder paste ISO-Cream® "EL 42/58" is a homogenous, ready-made and odourless mixture made of metal powder, bonding agents, solvents, fluxes and thixotropic agents.

This paste has excellent wetting qualities and is ideally suited for the soldering of temperature sensitive components. Variations of the solderability of joint surfaces and components will be tolerated without negative effect on the soldering result. The flux residues show a very high surface resistance.

The solder paste ISO-Cream® "EL 42/58" is insensitive to humidity and temperature. It shows no tendency to solder-ball formation on chip-resistors and capacitors.

FELDER \so-**Cream** "EL 42/58" has a very strong wet bonding force and is also suitable for machines with very high accelerations/decelerations. It has a very long stencil time and can be used in printing machines with a temperature control unit (very strong ventilation). The rheology of this paste has been optimized in order to achieve excellent printing qualities on narrow openings as well as a good first print after a break. Laboratory tests have shown that the first print after a break of 2 hours was unobjectionable. FELDER \so-**Cream** "EL 42/58" is excellently suitable for dispenser application, since the paste shows a very good contour stability also at low viscosities.

Properties

Alloy acc. to DIN EN ISO 9453	Melting point	Metal powder form	Metal powder content	Viscosity
Bi58Sn42	138° C	ball-shaped	80 - 89%	250.000 - 900.000 mPas

Grain size acc. to IPC: $3 = \text{Standard } 25 - 45 \,\mu\text{m}$

 $4 = \text{Fine-Pitch } 20 - 38 \,\mu\text{m}$ $5 = \text{Ultra-Fine-Pitch } 10 - 25 \,\mu\text{m}$

Flux: DIN EN 29454, 1.1.3.C, DIN EN 61190-1-3, ROL1, IPC J-STD-004B, ROL1

Stencil strength: Standard = $150 - 200 \mu m$

Fine-Pitch $= 100 - 150 \,\mu\text{m}$ Ultra-Fine Pitch $= 80 - 120 \,\mu\text{m}$ FELDER-ISO-Cream® "EL 42/58", Bi58Sn42



Organic Carrier Materials

The composition of ISO-Cream® "EL 42/58" – solder paste largely excludes an encrustation when stocked properly and assures the following rheological properties:

- excellent printability
- constant viscosity
- optimally suitable for dispenser application

Advantages

- solder temperatures are gentle to components
- little residues
- little content of volatiles ⇒ longer cleaning intervals of the reflow oven
- real no-clean-quality
- excellent printing quality ⇒ high stencil time of at least 24 hours
- unobjectionable soldering results with all common solder profiles
- stability of the viscosity also on print breaks

Processing Advices

- Before opening the container, the paste should have reached room temperature, so that there will be no condensation on the paste.
- Stir FELDER ISO-Cream® "EL 42/58" well before use.
- FELDER ISO-Cream® "EL 42/58" keeps its adhesive consistency for a long period which allows a trouble-free assembly of the circuit even after 2 hours. The exact period depends on the ambient conditions, size and form of the components as well as on the accelerations/decelerations on the line.
- The peak temperature depends on the thermal capacity of the components.
- FELDER ISO-Cream® "EL 42/58" can be soldered under air or inert gas.
- Used solder paste (e. g. rests on the stencil) should not be replaced into the jar because the durability
 of the unused paste will be reduced essentially. Used solder paste should be kept separately and if
 necessary should be mixed with fresh solder paste directly before use.

Washing

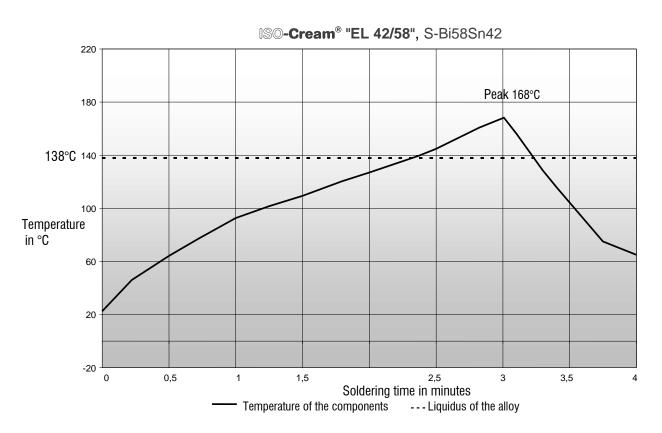
Since the solder paste reaches the highest "no-clean-level" the flux residues may remain on the soldered circuits and do not have to be washed away. Nevertheless, the residues also can be removed in conventional washing plants.

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Recommended Reflow Profile



Delivery Forms

Jars: 0,250 and 0,500 kg
Cartridges: 6 and 12 oz Semco®
Cassettes: ProFlow™ and PuckPack™

Dispenser cartridges: 5, 10 and 30 cc

Storage Advice

Store in tightly closed containers protected from humidity, insolation and heat. FELDER \bigcirc -Cream $^{\circ}$ "EL 42/58" is storable for at least 4 months (storage at constant temperature of 5 - 15° C).

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